



钜地半导体
Tudi Semiconductor

Product Specification

TUDI-BTA16

logic level and standard Triacs

网址 www.sztdbdt.com Q

用芯智造 · 卓越品质

semiconductor device
manufacturer

- Design
- research and development
- production
- and sales



Features

- Medium current Triac
- Low thermal resistance with clip bonding
- Low thermal resistance insulation ceramic for insulated BTA
- High commutation (4Q) or very high commutation (3Q) capability
- BTA series UL1557 certified (File ref: 81734)
- RoHS (2002/95/EC) compliant
- Insulated tab (BTA series, rated at 2500 VRMS)

Applications

- Snubberless versions (BTA/BTB...W and T1635) especially recommended for use on inductive loads, because of their high commutation performances
- On/off or phase angle function in applications such as static relays, light dimmers and appliance motor speed controllers

Description

Available either in through-hole or surface-mount packages, the BTA16, BTB16, T1610 and T1635 Triacs series are suitable for general purpose mains power AC switching.



Table 1. Device summary

Symbol	Parameter	BTA16 ⁽¹⁾	BTB16	T1610	T1635
$I_{T(RMS)}$	On-state rms current	16	16	16	16
V_{DRM}/V_{RRM}	Repetitive peak off-state voltage	600/800	600/800	600/800	600/800
I_{GT} (Snubberless)	Triggering gate current	35/50	35/50	-	35
I_{GT} (logic level)	Triggering gate current	10	10	10	-
I_{GT} (standard)	Triggering gate current	25/50	25/50	-	-

1. Insulated

TM: Snubberless is a trademark of STMicroelectronics

1 Characteristics

Table 2. Absolute maximum ratings

Symbol	Parameter			Value	Unit
$I_{T(RMS)}$	On-state rms current (full sine wave)	D ² PAK / TO-220AB	$T_c = 100\text{ }^{\circ}\text{C}$	16	A
		TO-220AB insulated	$T_c = 86\text{ }^{\circ}\text{C}$		
I_{TSM}	Non repetitive surge peak on-state current (full cycle, T_j initial = $25\text{ }^{\circ}\text{C}$)	F = 50 Hz	t = 20 ms	160	A
		F = 60 Hz	t = 16.7 ms	168	
I^2t	I^2t value for fusing	$t_p = 10\text{ ms}$		144	A^2s
di/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$, $t_r \leq 100\text{ ns}$	F = 120 Hz	$T_j = 125\text{ }^{\circ}\text{C}$	50	A/ μs
V_{DSM}/V_{RSM}	Non repetitive surge peak off-state voltage	$t_p = 10\text{ ms}$	$T_j = 25\text{ }^{\circ}\text{C}$	V_{DRM}/V_{RRM} + 100	V
I_{GM}	Peak gate current	$t_p = 20\text{ }\mu\text{s}$	$T_j = 125\text{ }^{\circ}\text{C}$	4	A
$P_{G(AV)}$	Average gate power dissipation		$T_j = 125\text{ }^{\circ}\text{C}$	1	W
T_{stg}	Storage temperature range			-40 to + 150	
T_j	Maximum operating junction temperature			-40 to + 125	



**Table 3. Electrical characteristics ($T_j = 25^\circ\text{C}$, unless otherwise specified)
Snubberless and logic level (3 quadrants)**

Symbol	Test conditions	Quadrant		T1610	T1635	BTA16 / BTB16			Unit
						SW	CW	BW	
$I_{GT}^{(1)}$	$V_D = 12\text{ V}$	I - II - III	Max.	10	35	10	35	50	mA
V_{GT}	$R_L = 33\ \Omega$	I - II - III	Max.	1.3					V
V_{GD}	$V_D = V_{DRM}$ $R_L = 3.3\text{ k}\Omega$ $T_j = 125^\circ\text{C}$	I - II - III	Min.	0.2					V
$I_H^{(2)}$	$I_T = 500\text{ mA}$		Max.	15	35	15	35	50	mA
I_L	$I_G = 1.2 I_{GT}$	I - III	Max.	25	50	25	50	70	mA
		II		30	60	30	60	80	
$dV/dt^{(2)}$	$V_D = 67\% V_{DRM}$ gate open	$T_j = 125^\circ\text{C}$	Min.	40	500	40	500	1000	V/ μs
$(dI/dt)_c^{(2)}$	$(dV/dt)_c = 0.1\text{ V}/\mu\text{s}$	$T_j = 125^\circ\text{C}$	Min.	8.5	-	8.5	-	-	A/ms
	$(dV/dt)_c = 10\text{ V}/\mu\text{s}$	$T_j = 125^\circ\text{C}$		3.0	-	3.0	-	-	
	Without snubber	$T_j = 125^\circ\text{C}$		-	8.5	-	8.5	14	

1. Minimum I_{GT} is guaranteed at 5% of $I_{GT}\text{ max}$

2. For both polarities of A2 referenced to A1



Table 4. Electrical characteristics ($T_j = 25\text{ }^{\circ}\text{C}$, unless otherwise specified) standard (4 quadrants)

Symbol	Test conditions	Quadrant		BTA16 / BTB16		Unit
				C	B	
$I_{GT}^{(1)}$	$V_D = 12\text{ V}$ $R_L = 33\text{ }\Omega$	I - II - III IV	Max.	25 50	50 100	mA
V_{GT}		ALL	Max.	1.3		V
V_{GD}	$V_D = V_{DRM}$ $R_L = 3.3\text{ k}\Omega$ $T_j = 125\text{ }^{\circ}\text{C}$	ALL	Min.	0.2		V
$I_H^{(2)}$	$I_T = 500\text{ mA}$		Max.	25	50	mA
I_L	$I_G = 1.2\text{ }I_{GT}$	I - III - IV	Max.	40	60	mA
		II		80	120	
$dV/dt^{(2)}$	$V_D = 67\text{ }\%V_{DRM}$ gate open	$T_j = 125\text{ }^{\circ}\text{C}$	Min.	200	400	V/ μs
$(dV/dt)_c^{(2)}$	$(dI/dt)_c = 7\text{ A/ms}$	$T_j = 125\text{ }^{\circ}\text{C}$	Min.	5	10	V/ μs

1. Minimum I_{GT} is guaranteed at 5% of I_{GT} max

2. For both polarities of A2 referenced to A1

Table 5. Static characteristics

Symbol	Test conditions			Value	Unit	
V_T (2)	$I_{TM} = 22.5\text{ A}$	$t_p = 380\text{ }\mu\text{s}$	$T_j = 25\text{ }^{\circ}\text{C}$	Max.	1.55	V
V_{to} (2)	Threshold voltage		$T_j = 125\text{ }^{\circ}\text{C}$	Max.	0.85	V
R_d (2)	Dynamic resistance		$T_j = 125\text{ }^{\circ}\text{C}$	Max.	25	mΩ
I_{DRM} I_{RRM}	$V_{DRM} = V_{RRM}$		$T_j = 25\text{ }^{\circ}\text{C}$	Max.	5	μA
			$T_j = 125\text{ }^{\circ}\text{C}$		2	mA

Table 6. Thermal resistance

Symbol	Parameter		Value	Unit
$R_{th(j-c)}$	Junction to case (AC)	D ² PAK / TO-220AB	1.2	$^{\circ}\text{C/W}$
		TO-220AB insulated	2.1	
$R_{th(j-a)}$	Junction to ambient	$S^{(1)} = 1\text{ cm}^2$ D ² PAK	45	$^{\circ}\text{C/W}$
		TO-220AB / TO-220AB insulated	60	

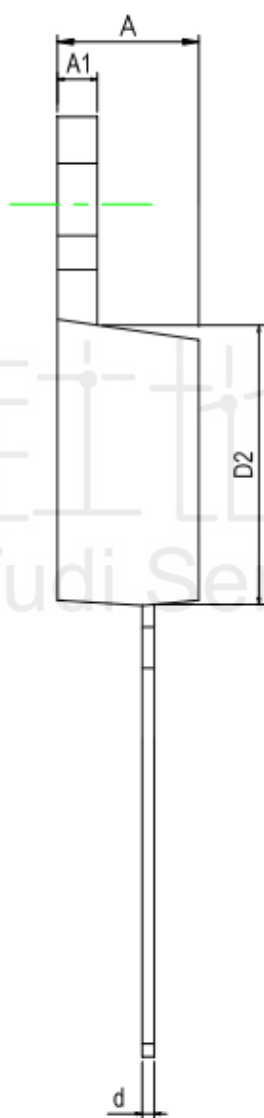
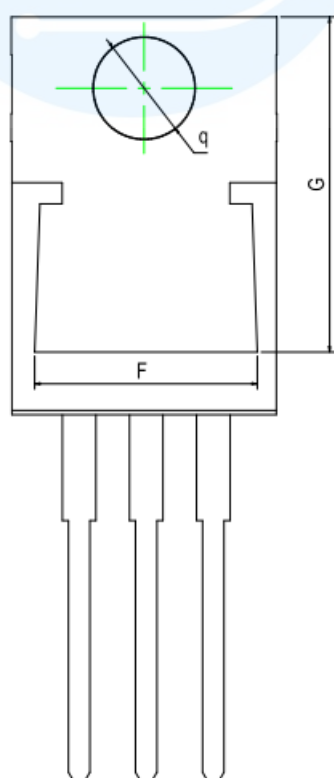
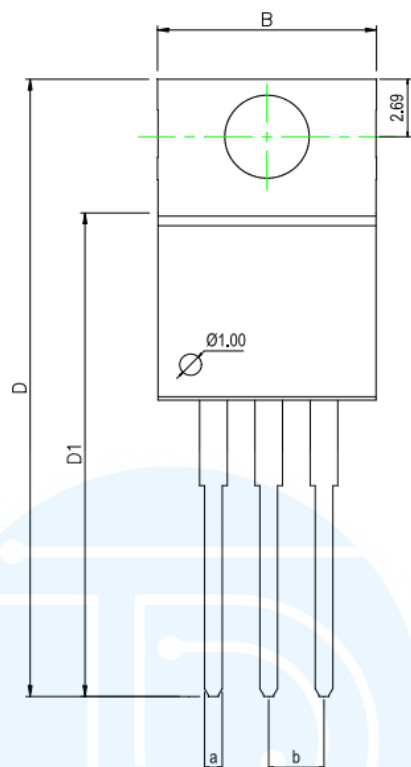
1. S = Copper surface under tab



Order information

Order Number	Package	Package Quantity	Marking On The park
BTA16-600BRG-TUDI	TO220	Tube,50,A box of 1000	BTA16-600BRG

Package TO220-3



Symbol:	Min:	Max:
A	4.45	4.62
A1	1.22	1.32
B	10	10.4
D	28.2	28.9
D1	22.22	22.62
D2	8.5	9.1
F	8.3	8.55
G	12.55	12.75
a	0.71	0.97
d	0.33	0.42
b	2.54BSC	
q	3.8TYP	



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